#### 74AC11257 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER WITH 3-STATE OUTPUTS

SCAS049C - MARCH 1989 - REVISED MAY 2004

<ul> <li>3-State Outputs Interface Directly With</li></ul>	DB, DW, N, OR PW PACKAGE						
System Bus	(TOP VIEW)						
<ul> <li>Flow-Through Architecture Optimizes</li></ul>	Ā/B [	1	20	] 1A			
PCB Layout	1 Y [	2	19	] 1B			
<ul> <li>Center-Pin V<sub>CC</sub> and GND Configurations Minimize High-Speed Switching Noise</li> </ul>	2Y [ GND ]	2 3 4		<b>F</b>			
<ul> <li>500-mA Typical Latch-Up Immunity at</li></ul>	GND [	5	16	] v <sub>cc</sub>			
125°C	GND [	6	15	] v <sub>cc</sub>			
<ul> <li>Provides Bus Interface From Multiple Sources in High-Performance Systems</li> </ul>	GND [ 3Y [	7 8	1	6 _			
description/ordering information	4Y [	9	12	] 4A			
	OE [	10	11	] 4B			

This device is designed to multiplex signals from 4-bit data sources to four output data lines in bus-organized systems. The 3-state outputs do not load the data lines when the output-enable (OE) input is at a high logic level.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

T <sub>A</sub>	PACK	AGE <sup>†</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	74AC11257N	74AC11257N
		Tube	74AC11257DW	4011057
4000 to 0500	SOIC – DW	Tape and reel	74AC11257DWR	AC11257
–40°C to 85°C	SSOP – DB	Tape and reel	74AC11257DBR	AE257
		Tube	74AC11257PW	45057
	TSSOP – PW	Tape and reel	74AC11257PWR	AE257

#### **ORDERING INFORMATION**

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

	INPUTS								
~-	SELECT	DA	TA						
ŌE	Ā/B	Ā/B A B		•					
Н	Х	Х	Х	Z					
L	L	L	х	L					
L	L	н	Х	Н					
L	н	Х	L	L					
L	н	х	Н	Н					

#### FUNCTION TABLE



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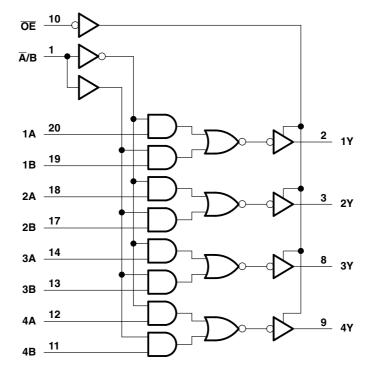
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



## 74AC11257 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER WITH 3-STATE OUTPUTS

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#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



## 74AC11257 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER

WITH 3-STATE OUTPUTS SCAS049C - MARCH 1989 - REVISED MAY 2004

#### recommended operating conditions (see Note 3)

			MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage		3	5	5.5	V
		$V_{CC} = 3 V$	2.1			
V <sub>IH</sub>	High-level input voltage	$V_{CC} = 4.5 V$	3.15			V
		$V_{CC} = 5.5 V$	3.85			
V <sub>IL</sub>		$V_{CC} = 3 V$			0.9	
	Low-level input voltage V <sub>CC</sub> = 4.5 V				1.35	V
		$V_{CC} = 5.5 V$			1.65	
VI	Input voltage		0		$V_{CC}$	V
Vo	Output voltage		0		$V_{CC}$	V
		$V_{CC} = 3 V$			-4	
I <sub>OH</sub>	High-level output current	$V_{CC} = 4.5 V$			-24	mA
		V <sub>CC</sub> = 5.5 V			-24	
		$V_{CC} = 3 V$			12	
l <sub>OL</sub>	Low-level output current	$V_{CC} = 4.5 V$			24	mA
		V <sub>CC</sub> = 5.5 V			24	
$\Delta t/\Delta v$	Input transition rise or fall rate				10	ns/V
T <sub>A</sub>	Operating free-air temperature	-40		85	°C	

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			T,	₄ = 25°C				
PARAMETER	TEST CONDITIONS	v <sub>cc</sub>	MIN	TYP	MAX	MIN	MAX	UNIT
		3 V	2.9			2.9		
	I <sub>OH</sub> = -50 μA	4.5 V	4.4			4.4		
		5.5 V	5.4			5.4		
V <sub>OH</sub>	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		V
		4.5 V	3.94			3.8		
	$I_{OH} = -24 \text{ mA}$	5.5 V	4.94			4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
		3 V			0.1		0.1	
	l <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1	
		5.5 V			0.1		0.1	
V <sub>OL</sub>	$I_{OL} = 12 \text{ mA}$	3 V			0.36		0.44	V
	L 04 m A	4.5 V			0.36		0.44	
	$I_{OL} = 24 \text{ mA}$	5.5 V			0.36		0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
I <sub>OZ</sub>	$V_{O} = V_{CC}$ or GND	5.5 V			±0.5		±5	μA
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V			±0.1		±1	μA
I <sub>CC</sub>	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			8		80	μA
Ci	$V_{I} = V_{CC}$ or GND	5 V		3.5				pF
Co	$V_{O} = V_{CC}$ or GND	5.5 V		8				pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.



#### 74AC11257 **QUADRUPLE 2-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER** WITH 3-STATE OUTPUTS SCAS049C - MARCH 1989 - REVISED MAY 2004

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	Т	<sub>A</sub> = 25°C	;	MIN	MAY	
PARAMETER	(INPUT)	(OUTPUT)	MIN	ТҮР	MAX	WIIN	MAX	UNIT
t <sub>PLH</sub>	A ar D	v	1.5	5.6	8.1	1.5	8.9	
t <sub>PHL</sub>	A or B	ř	1.5	6.2	9	1.5	10.1	ns
t <sub>PLH</sub>	Ā/B	Amerik	1.5	6.1	9.2	1.5	10.2	
t <sub>PHL</sub>		Any Y	1.5	6.6	10	1.5	11.2	ns
t <sub>PZH</sub>				5.6	8.2	1.5	9.1	
t <sub>PZL</sub>	OE	Any Y	1.5	7.5	10.4	1.5	11.8	ns
t <sub>PHZ</sub>		Anu V	1.5	5.6	7.6	1.5	8.3	
t <sub>PLZ</sub>	ŌĒ	Any Y	1.5	6.2	8.8	1.5	9.6	ns

# switching characteristics, over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	T,	₄ = 25°C	;	MIN		
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIIN	MAX	UNIT
t <sub>PLH</sub>	A	v	1.5	3.6	5.8	1.5	6.4	
t <sub>PHL</sub>	A or B	ř	1.5	4.1	6.5	1.5	7.2	ns
t <sub>PLH</sub>	Te	Amerik	1.5	4	6.5	1.5	7.2	
t <sub>PHL</sub>	Ā/B	Any Y	1.5	4.4	7.1	1.5	7.9	ns
t <sub>PZH</sub>				3.8	5.9	1.5	6.5	
t <sub>PZL</sub>	ŌĒ	Any Y	1.5	5	7.6	1.5	8.6	ns
t <sub>PHZ</sub>		Amerik	1.5	4.5	6.4	1.5	7.6	
t <sub>PLZ</sub>	OE	Any Y	1.5	4.8	6.9	1.5	7.6	ns

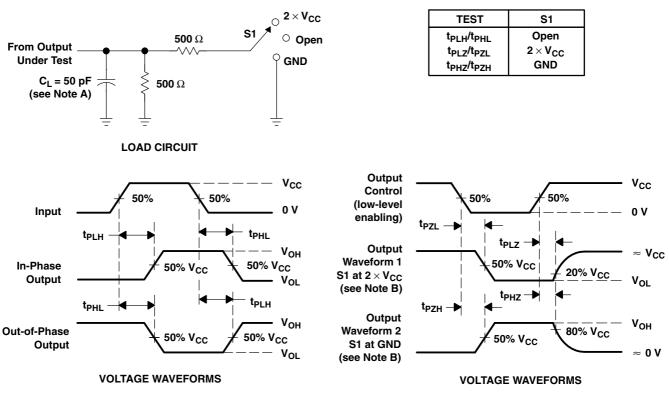
### operating characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

	PARAMETER	TEST CO	TYP	UNIT		
C <sub>pd</sub>	Descending the strengtheness of the second	Outputs enabled	0 50		37	
	Power dissipation capacitance	Outputs disabled	C <sub>L</sub> = 50 pF,	f = 1 MHz	11	pF



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#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
   C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z<sub>Ω</sub> = 50 Ω, t<sub>r</sub> = 3 ns, t<sub>f</sub> = 3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms





#### PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins	-	Eco Plan	Lead finish/	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	Ball material	(3)		(4/5)	
				_			(6)				
74AC11257DW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AC11257	Samples
74AC11257N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	-40 to 85	74AC11257N	Samples
74AC11257PW	ACTIVE	TSSOP	PW	20	70	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AE257	Samples
74AC11257PWG4	ACTIVE	TSSOP	PW	20	70	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AE257	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  $\beta$ . This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153



## LAND PATTERN DATA



NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
  C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



# **DW0020A**



## **PACKAGE OUTLINE**

### SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



# DW0020A

# **EXAMPLE BOARD LAYOUT**

## SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



## DW0020A

# **EXAMPLE STENCIL DESIGN**

## SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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